



	TEC	CHNICAL DATA SH	IEET	2/5
	EDGE CARE		R199.006.813	
Р	ACKAGING BY		Series : MOEBIUS	
	PACKAGING	<b>SPECIFICATION</b>		
Standard Unit Other				
100	'W' option	Contact us		
ELECTRI	CAL CHARACT	<b>ENVIRONMENTAL</b>		
Impedance Frequency VSWR (not mated ) VSWR (mated with p *Insertion loss DC to *Insertion loss 2 to 3 *Insertion loss 3 to 6 * not mated with PCl	1.2+0.           plug)         1.05+0           0 2 Ghz         0           Ghz         0           Ghz         0	<ul> <li>50 Ω</li> <li>0-6 GHz</li> <li>05 x F(GHz) Maxi</li> <li>0.5 x F(GHz) Maxi</li> <li>0.15 dB Maxi</li> <li>0.2 dB Maxi</li> <li>0.5 dB Maxi</li> </ul>	Operating tempe Hermetic seal i Panel leakage	erature -40/+110 ° C Atm.cm3/s
**Isolation loss DC t **Isolation loss 1 to **Isolation loss 3 to ** mated with plug	3Ghz	<ul> <li>30 dB min</li> <li>20 dB min</li> <li>20 dB min</li> </ul>	OTHER CHARACTERISTICS Assembly instruction	
Voltage rating Dielectric withstandi Insulation resistance	ng voltage	<ul><li>100 Veff Maxi</li><li>250 Veff mini</li><li>000 MΩ mini</li></ul>	Condition test : 10	rical discontinuity of 10 µs or more ) to 500 Hz , single amplitude of 1.5 g , 2 hours in each of the 3 axis
Mating life Weight	<u>ICAL CHARACT</u> 2500 0,37000	00 Cycles		
<b>Issue :</b> 0717 A In the effort to improve necessary.	e our products, we reser	we the right to make ch	anges judged to be	RADIALL®

#### TECHNICAL DATA SHEET

# **EDGE CARD SWITCH**

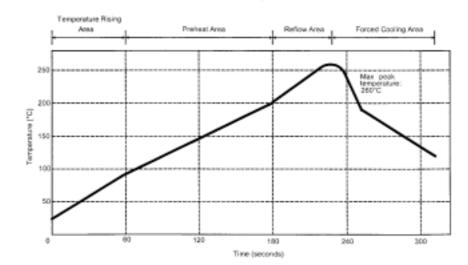
# PACKAGING BY REEL OF 100

R199.006.813

Series : MOEBIUS

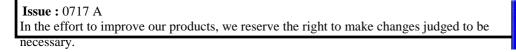
# SOLDER PROCEDURE

- Deposition of solder paste 'Sn Ag4 Cu0.5' on mounting zone by screen printing application. We recommend a low residue flux. We advise a thickness of 150 microns mini ( 0.006 inch mini ). Verify that the edges of the zone are clean.
- Placement of the receptacle on the mounting zone with an automatic machine of 'pick and place' type.
   Video camera is recommended for the positioning of the component. Adhesive agents must not be used on the receptacle.
- 3. Soldering by infra-red reflow. Below, please find the typical profile to use.
- 4. Cleaning of printed circuit boards.
- 5. Checking of solder joints and position of the component by visual inspection.

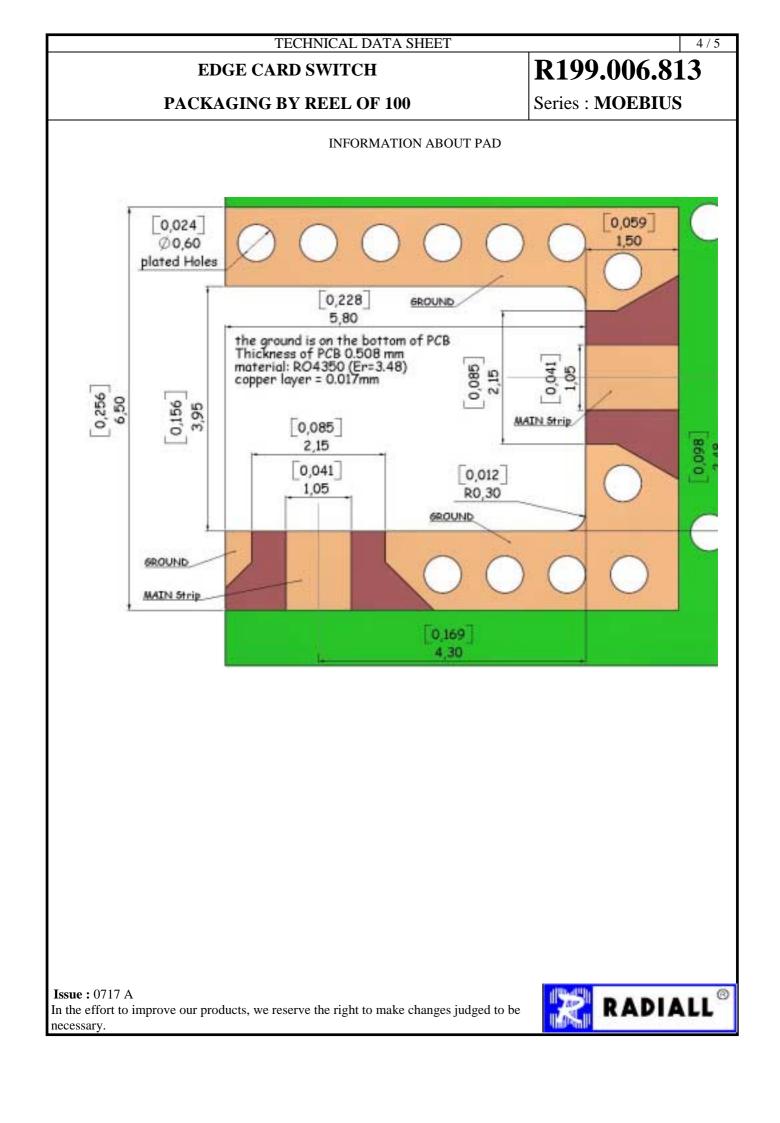


### **TEMPERATURE PROFILE**

Parameter	Value	Unit
Temperature rising Area	1 - 4	°C/sec
Max Peak Temperature	260	°C
Max dwell time @260°C	10	sec
Min dwell time @235°C	20	sec
Max dwell time @235°C	60	sec
Temperature drop in cooling Area	-1 to - 4	°C/sec
Max dwell time above 100°C	420	sec









### **EDGE CARD SWITCH**

# **PACKAGING BY REEL OF 100**

R199.006.813

5/5

Series : MOEBIUS



100 pieces by reel full package on reel (dia 180 mm 7.08 inch), weight of on reel =0.2 Kg

Suction area diameter 3 mm 0.118 inch

**Issue :** 0717 A In the effort to improve our products, we reserve the right to make changes judged to be necessary.

